

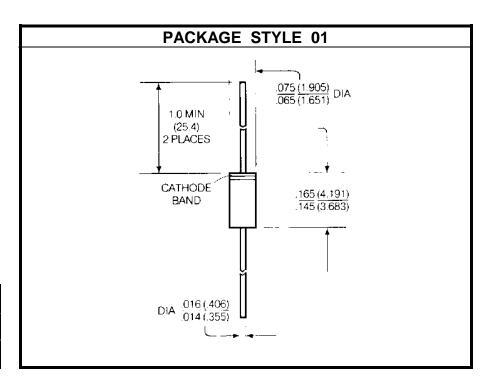
SILICON PIN DIODE CHIP

DESCRIPTION:

The **AP300A-00** is a Passivated Epitaxial Silicon PIN Diode Housed in a Hermetically Sealed Glass Package. This Device is Designed to Cover a Wide Range of Control Applications Such as RF Switching, Phase Shifting, Modulation, Duplexing Limiting and Pulse Forming.

MAXIMUM RATINGS

I _F	100 mA					
V_{R}	300 V					
P _{DISS}	250 mW @ $T_A = 25$ °C					



CHARACTERISTICS T_C = 25 °C

SYMBOL	TE	EST CONDITIO	NS	MINIMUM	TYPICAL	MAXIMUM	UNITS
V_{BR}	$I_R = 10 \mu A$			300			V
CJ	V _R = 50 V V _R = 40 V		f = 1.0 MHz			0.2	pF
R _s	I _F = 50 mA		f = 100 MHz			0.6	Ohms
TL	I _F = 10 mA	$I_R = 6.0 \text{ mA}$			1000		nS
T_{rr}	I _F = 20 mA	$I_R = 100 \text{ mA}$			100		nS
O _R	THERMAL RESI	STANCE				20	°C/W